E·XFL



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	40/20MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	-
Program Memory Type	ROMIess
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-PQFP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ts80c31x2-mcc

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



3. Block Diagram





4. SFR Mapping

The Special Function Registers (SFRs) of the TS80C31X2 fall into the following categories:

- C51 core registers: ACC, B, DPH, DPL, PSW, SP, AUXR1
- I/O port registers: P0, P1, P2, P3
- Timer registers: TCON, TH0, TH1, TMOD, TL0, TL1
- Serial I/O port registers: SADDR, SADEN, SBUF, SCON
- Power and clock control registers: PCON
- Interrupt system registers: IE, IP, IPH
- Others: CKCON

Table 1. All SFRs with their address and their reset value

	Bit address- able			Non	n Bit address	able			
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	
F8h									FFh
F0h	B 0000 0000								F7h
E8h									EFh
E0h	ACC 0000 0000								E7h
D8h									DFh
D0h	PSW 0000 0000								D7h
C8h									CFh
C0h									C7h
B8h	IP XXX0 0000	SADEN 0000 0000							BFh
B0h	P3 1111 1111							IPH XXX0 0000	B7h
A8h	IE 0XX0 0000	SADDR 0000 0000							AFh
A0h	P2 1111 1111		AUXR1 XXXX XXX0						A7h
98h	SCON 0000 0000	SBUF XXXX XXXX							9Fh
90h	P1 1111 1111								97h
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000		CKCON XXXX XXX0	8Fh
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00X1 0000	87h
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	

reserved



5. Pin Configuration



*NIC: No Internal Connection



Table 4. AUXR1: Auxiliary Register 1

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	DPS

Bit Number	Bit Mnemonic	Description
7	-	Reserved The value read from this bit is indeterminate. Do not set this bit.
6	-	Reserved The value read from this bit is indeterminate. Do not set this bit.
5	-	Reserved The value read from this bit is indeterminate. Do not set this bit.
4	-	Reserved The value read from this bit is indeterminate. Do not set this bit.
3	-	Reserved The value read from this bit is indeterminate. Do not set this bit.
2	-	Reserved The value read from this bit is indeterminate. Do not set this bit.
1	-	Reserved The value read from this bit is indeterminate. Do not set this bit.
0	DPS	Data Pointer Selection Clear to select DPTR0. Set to select DPTR1.

Reset Value = XXXX XXX0 Not bit addressable

Application

Software can take advantage of the additional data pointers to both increase speed and reduce code size, for example, block operations (copy, compare, search ...) are well served by using one data pointer as a 'source' pointer and the other one as a "destination" pointer.



ASSEMBLY LANGUAGE

; Block move using dual data pointers ; Destroys DPTR0, DPTR1, A and PSW ; note: DPS exits opposite of entry state ; unless an extra INC AUXR1 is added

00A2 AUXR1 EQU 0A2H 0000 909000MOV DPTR,#SOURCE : address of SOURCE 0003 05A2 INC AUXR1 ; switch data pointers 0005 90A000 MOV DPTR,#DEST ; address of DEST 0008 LOOP: 0008 05A2 INC AUXR1 ; switch data pointers ; get a byte from SOURCE 000A E0 MOVX A, @DPTR INC DPTR ; increment SOURCE address 000B A3 ; switch data pointers 000C 05A2 INC AUXR1 000E F0 MOVX @DPTR,A ; write the byte to DEST 000F A3 INC DPTR : increment DEST address 0010 70F6 JNZ LOOP ; check for 0 terminator 0012 05A2 INC AUXR1 ; (optional) restore DPS

INC is a short (2 bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.



Software may examine FE bit after each reception to check for data errors. Once set, only software or a reset can clear FE bit. Subsequently received frames with valid stop bits cannot clear FE bit. When FE feature is enabled, RI rises on stop bit instead of the last data bit (See Figure 5. and Figure 6.).







Figure 6. UART Timings in Modes 2 and 3

6.3.2 Automatic Address Recognition

The automatic address recognition feature is enabled when the multiprocessor communication feature is enabled (SM2 bit in SCON register is set).

Implemented in hardware, automatic address recognition enhances the multiprocessor communication feature by allowing the serial port to examine the address of each incoming command frame. Only when the serial port recognizes its own address, the receiver sets RI bit in SCON register to generate an interrupt. This ensures that the CPU is not interrupted by command frames addressed to other devices.

If desired, you may enable the automatic address recognition feature in mode 1. In this configuration, the stop bit takes the place of the ninth data bit. Bit RI is set only when the received command frame address matches the device's address and is terminated by a valid stop bit.

To support automatic address recognition, a device is identified by a given address and a broadcast address.

NOTE: The multiprocessor communication and automatic address recognition features cannot be enabled in mode 0 (i.e. setting SM2 bit in SCON register in mode 0 has no effect).



6.3.5 Reset Addresses

On reset, the SADDR and SADEN registers are initialized to 00h, i.e. the given and broadcast addresses are XXXX (all don't-care bits). This ensures that the serial port will reply to any address, and so, that it is backwards compatible with the 80C51 microcontrollers that do not support automatic address recognition.

SADEN - Slave Address Mask Register (B9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b Not bit addressable

SADDR - Slave Address Register (A9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b Not bit addressable



Table 5. SCON Register

SCON - Serial Control Register (98h)

7	6	5	4	ļ	3	2	1	0	
FE/SM0	SM1	SM2	RE	2N	TB8	RB8	TI	RI	
Bit Number	Bit Mnemonic				Descrip	tion			
7	FE	Framing Error I Clear to reset Set by hardw SMOD0 mus	it (SMOD0 = the error state are when an ir t be set to enal	1) e, not cle nvalid sto ble acces	eared by a valid sto op bit is detected. ss to the FE bit	p bit.			
	SM0	Serial port Mode Refer to SMI SMOD0 mus	e bit 0 for serial por t be cleared to	rt mode s enable a	selection. access to the SM0	bit			
		Serial port Mode SM0	e bit 1 SM1	Mode	Descriptio	on Baud Rate	2		
6	SM1	0 0 1 1	0 1 0 1	0 1 2 3	Shift Reg 8-bit UAF 9-bit UAF 9-bit UAF	ister F _{XTAL} /1 RT Variable RT F _{XTAL} /6 RT Variable	2 (/6 in X2 mode) 4 or F _{XTAL} /32 (/32	e, /16 in X2 mode)	
5	SM2	Serial port Mode 2 bit / Multiprocessor Communication Enable bit Clear to disable multiprocessor communication feature. Set to enable multiprocessor communication feature in mode 2 and 3, and eventually mode 1. This bit should be cleared in mode 0.							
4	REN	Reception Enabl Clear to disal Set to enable	e bit ble serial recep serial reception	ption. on.					
3	TB8	Transmitter Bit Clear to trans Set to transm	8 / Ninth bit t mit a logic 0 i it a logic 1 in	to transr in the 9th the 9th b	nit in modes 2 an h bit. bit.	13.			
2	RB8	Receiver Bit 8 / I Cleared by h Set by hardw In mode 1, if	Receiver Bit 8 / Ninth bit received in modes 2 and 3 Cleared by hardware if 9th bit received is a logic 0. Set by hardware if 9th bit received is a logic 1. In mode 1, if SM2 = 0, RB8 is the received stop bit. In mode 0 RB8 is not used.						
1	TI	Transmit Interro Clear to ackn Set by hardw modes.	Transmit Interrupt flag Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0 or at the beginning of the stop bit in the other modes.						
0	RI	Receive Interrup Clear to ackn Set by hardw	t flag owledge inter are at the end	rupt. of the 8t	h bit time in mode	0, see Figure 5. a	and Figure 6. in the	other modes.	

Reset Value = 0000 0000b Bit addressable



Table 6. PCON Register

PCON - Power Control Register (87h)

7	6	5	4	3	2	1	0			
SMOD1 SMOD0) -	POF	GF1	GF0	PD	IDL			
Bit Number	Bit Mnemonic		Description							
7	SMOD1	Serial port Mode bi Set to select dou	Serial port Mode bit 1 Set to select double baud rate in mode 1, 2 or 3.							
6	SMOD0	Serial port Mode bi Clear to select S Set to to select F	Serial port Mode bit 0 Clear to select SM0 bit in SCON register. Set to to select FE bit in SCON register.							
5	-	Reserved The value read fr	Reserved The value read from this bit is indeterminate. Do not set this bit.							
4	POF	Power-Off Flag Clear to recogniz Set by hardware	e next reset type. when VCC rises fi	rom 0 to its nomin	al voltage. Can also	be set by softwar	e.			
3	GF1	General purpose Fla Cleared by user Set by user for g	ag for general purpose eneral purpose usa	e usage. Ige.						
2	GF0	General purpose Fla Cleared by user Set by user for g	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.							
1	PD	Power-Down mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.								
0	IDL	Idle mode bit Clear by hardwa Set to enter idle	re when interrupt on mode.	or reset occurs.						

Reset Value = 00X1 0000b Not bit addressable

Power-off flag reset value will be 1 only after a power on (cold reset). A warm reset doesn't affect the value of this bit.



6.4 Interrupt System

The TS80C31X2 has a total of 5 interrupt vectors: two external interrupts ($\overline{INT0}$ and $\overline{INT1}$), two timer interrupts (timers 0 and 1) and the serial port interrupt. These interrupts are shown in Figure 7.



Figure 7. Interrupt Control System

Each of the interrupt sources can be individually enabled or disabled by setting or clearing a bit in the Interrupt Enable register (See Table 8.). This register also contains a global disable bit, which must be cleared to disable all interrupts at once.

Each interrupt source can also be individually programmed to one out of four priority levels by setting or clearing a bit in the Interrupt Priority register (See Table 9.) and in the Interrupt Priority High register (See Table 10.). shows the bit values and priority levels associated with each combination.



IP - Interrupt Priority Register (B8h)

7	6	5	4	3	2	1	0			
-	-	-	PS	PT1	PX1	PT0	PX0			
Bit Number	Bit Mnemonic		Description							
7	-	Reserved The value read f	rom this bit is inde	eterminate. Do not s	set this bit.					
6	-	Reserved The value read f	Reserved The value read from this bit is indeterminate. Do not set this bit.							
5	-	Reserved The value read f	Reserved The value read from this bit is indeterminate. Do not set this bit.							
4	PS	Serial port Priority Refer to PSH fo	bit r priority level.							
3	PT1	Timer 1 overflow in Refer to PT1H f	terrupt Priority I for priority level.	bit						
2	PX1	External interrupt Refer to PX1H	External interrupt 1 Priority bit Refer to PX1H for priority level.							
1	PT0	Timer 0 overflow in Refer to PT0H f	Timer 0 overflow interrupt Priority bit Refer to PT0H for priority level.							
0	PX0	External interrupt Refer to PX0H	0 Priority bit for priority level.							

Reset Value = XXX0 0000b Bit addressable



Mode	Program Memory	ALE	PSEN	PORT0	PORT1	PORT2	PORT3
Idle	External	1	1	Floating	Port Data	Address	Port Data
Power Down	External	0	0	Floating	Port Data	Port Data	Port Data

Table 11. The state of ports during idle and power-down modes



6.7 ONCETM Mode (ON Chip Emulation)

The ONCE mode facilitates testing and debugging of systems using TS80C31X2 without removing the circuit from the board. The ONCE mode is invoked by driving certain pins of the TS80C31X2; the following sequence must be exercised:

- Pull ALE low while the device is in reset (RST high) and $\overline{\text{PSEN}}$ is high.
- Hold ALE low as RST is deactivated.

While the TS80C31X2 is in ONCE mode, an emulator or test CPU can be used to drive the circuit Table 26. shows the status of the port pins during ONCE mode.

Normal operation is restored when normal reset is applied.

Table 12. External Pin Status during ONCE Mode

ALE	PSEN	Port 0	Port 1	Port 2	Port 3	XTAL1/2
Weak pull-up	Weak pull-up	Float	Weak pull-up	Weak pull-up	Weak pull-up	Active



6.8 Power-Off Flag

The power-off flag allows the user to distinguish between a "cold start" reset and a "warm start" reset.

A cold start reset is the one induced by V_{CC} switch-on. A warm start reset occurs while V_{CC} is still applied to the device and could be generated for example by an exit from power-down.

The power-off flag (POF) is located in PCON register (See Table 13.). POF is set by hardware when V_{CC} rises from 0 to its nominal voltage. The POF can be set or cleared by software allowing the user to determine the type of reset.

The POF value is only relevant with a Vcc range from 4.5V to 5.5V. For lower Vcc value, reading POF bit will return indeterminate value.

Table 13. PCON Register

PCON - Power Control Register (87h)

7	6	5	4	3	2	1	0				
SMOD1	SMOD) -	POF	GF1	GF0	PD	IDL				
Bit Number	Bit Mnemonic		Description								
7	SMOD1	Serial port Mode bi Set to select dou	Serial port Mode bit 1 Set to select double baud rate in mode 1, 2 or 3.								
6	SMOD0	Serial port Mode bi Clear to select S Set to to select F	Serial port Mode bit 0 Clear to select SM0 bit in SCON register. Set to to select FE bit in SCON register.								
5	-	Reserved The value read f	Reserved The value read from this bit is indeterminate. Do not set this bit.								
4	POF	Power-Off Flag Clear to recogniz Set by hardware	Power-Off Flag Clear to recognize next reset type. Set by hardware when V _{CC} rises from 0 to its nominal voltage. Can also be set by software.								
3	GF1	General purpose Flac Cleared by user Set by user for g	ag for general purpose eneral purpose usa	e usage. ge.							
2	GF0	General purpose Flac Cleared by user Set by user for g	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.								
1	PD	Power-Down mode bit Cleared by hardware when reset occurs. Set to enter power-down mode.									
0	IDL	Idle mode bit Clear by hardwa Set to enter idle	re when interrupt of mode.	or reset occurs.							

Reset Value = 00X1 0000b Not bit addressable



7. Electrical Characteristics

7.1 Absolute Maximum Ratings ⁽¹⁾

Ambiant Temperature Under Bias:	
C = commercial	$0^{\circ}C$ to $70^{\circ}C$
I = industrial	-40°C to 85°C
Storage Temperature	$-65^{\circ}C$ to $+ 150^{\circ}C$
Voltage on V_{CC} to V_{SS}	-0.5 V to + 7 V
Voltage on V_{PP} to V_{SS}	-0.5 V to + 13 V
Voltage on Any Pin to V _{SS}	-0.5 V to V_{CC} + 0.5 V
Power Dissipation	$1 W^{(2)}$

NOTES

1. Stresses at or above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.

2. This value is based on the maximum allowable die temperature and the thermal resistance of the package.

7.2 Power consumption measurement

Since the introduction of the first C51 devices, every manufacturer made operating Icc measurements under reset, which made sense for the designs were the CPU was running under reset. In Atmel Wireless & Microcontrollers new devices, the CPU is no more active during reset, so the power consumption is very low but is not really representative of what will happen in the customer system. That's why, while keeping measurements under Reset, Atmel Wireless & Microcontrollers presents a new way to measure the operating Icc:

Using an internal test ROM, the following code is executed:

Label: SJMP Label (80 FE)

Ports 1, 2, 3 are disconnected, Port 0 is tied to FFh, EA = Vcc, RST = Vss, XTAL2 is not connected and XTAL1 is driven by the clock.

This is much more representative of the real operating Icc.



Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
I _{CC} operating	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			3 + 0.6 Freq (MHz) @12MHz 10.2 @16MHz 12.6	mA	$V_{CC} = 5.5 V^{(8)}$
I _{CC} idle	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			0.25+0.3Freq (MHz) @12MHz 3.9 @16MHz 5.1	mA	$V_{CC} = 5.5 V^{(2)}$

7.4 DC Parameters for Low Voltage

TA = 0°C to +70°C; V_{SS} = 0 V; V_{CC} = 2.7 V to 5.5 V ± 10%; F = 0 to 30 MHz. TA = -40°C to +85°C; V_{SS} = 0 V; V_{CC} = 2.7 V to 5.5 V ± 10%; F = 0 to 30 MHz.

Table 15. DC Parameters for Low Voltage

Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
V _{IL}	Input Low Voltage	-0.5		0.2 V _{CC} - 0.1	V	
V _{IH}	Input High Voltage except XTAL1, RST	0.2 V _{CC} + 0.9		V _{CC} + 0.5	V	
V _{IH1}	Input High Voltage, XTAL1, RST	0.7 V _{CC}		V _{CC} + 0.5	V	
V _{OL}	Output Low Voltage, ports 1, 2, 3 ⁽⁶⁾			0.45	V	$I_{OL} = 0.8 \text{ mA}^{(4)}$
V _{OL1}	Output Low Voltage, port 0, ALE, PSEN (6)			0.45	V	$I_{OL} = 1.6 \text{ mA}^{(4)}$
V _{OH}	Output High Voltage, ports 1, 2, 3	0.9 V _{CC}			V	$I_{OH} = -10 \ \mu A$
V _{OH1}	Output High Voltage, port 0, ALE, PSEN	0.9 V _{CC}			V	$I_{OH} = -40 \ \mu A$
I _{IL}	Logical 0 Input Current ports 1, 2 and 3			-50	μΑ	Vin = 0.45 V
I _{LI}	Input Leakage Current			±10	μΑ	0.45 V < Vin < V _{CC}
I _{TL}	Logical 1 to 0 Transition Current, ports 1, 2, 3			-650	μΑ	Vin = 2.0 V
R _{RST}	RST Pulldown Resistor	50	90 ⁽⁵⁾	200	kΩ	
CIO	Capacitance of I/O Buffer			10	pF	$Fc = 1 MHz$ $TA = 25^{\circ}C$
I _{PD}	Power Down Current		20 ⁽⁵⁾ 10 ⁽⁵⁾	50 30	μΑ	$V_{CC} = 2.0 \text{ V to } 5.5 \text{ V}^{(3)}$ $V_{CC} = 2.0 \text{ V to } 3.3 \text{ V}^{(3)}$
I _{CC} under RESET	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			1 + 0.2 Freq (MHz) @12MHz 3.4 @16MHz 4.2	mA	$V_{CC} = 3.3 V^{(1)}$
I _{CC} operating	Power Supply Current Maximum values, X1 mode: ⁽⁷⁾			1 + 0.3 Freq (MHz) @12MHz 4.6 @16MHz 5.8	mA	$V_{CC} = 3.3 V^{(8)}$



7.5 AC Parameters

7.5.1 Explanation of the AC Symbols

Each timing symbol has 5 characters. The first character is always a "T" (stands for time). The other characters, depending on their positions, stand for the name of a signal or the logical status of that signal. The following is a list of all the characters and what they stand for.

Example: T_{AVLL} = Time for Address Valid to ALE Low. T_{LLPL} = Time for ALE Low to PSEN Low.

TA = 0 to +70°C (commercial temperature range); $V_{SS} = 0$ V; $V_{CC} = 5$ V ± 10%; -M and -V ranges. TA = -40°C to +85°C (industrial temperature range); $V_{SS} = 0$ V; $V_{CC} = 5$ V ± 10%; -M and -V ranges. TA = 0 to +70°C (commercial temperature range); $V_{SS} = 0$ V; 2.7 V < $V_{CC} < 5.5$ V; -L range. TA = -40°C to +85°C (industrial temperature range); $V_{SS} = 0$ V; 2.7 V < $V_{CC} < 5.5$ V; -L range.

Table 16. gives the maximum applicable load capacitance for Port 0, Port 1, 2 and 3, and ALE and $\overline{\text{PSEN}}$ signals. Timings will be guaranteed if these capacitances are respected. Higher capacitance values can be used, but timings will then be degraded.

	-M	-V	-L
Port 0	100	50	100
Port 1, 2, 3	80	50	80
ALE / PSEN	100	30	100

Table	16.	Load	Capacitance	versus	speed	range,	in	pF
			Capacita in the second		opeeu.			r-

Table 18., Table 21. and Table 24. give the description of each AC symbols.

Table 19., Table 22. and Table 25. give for each range the AC parameter.

Table 20., Table 23. and Table 26. give the frequency derating formula of the AC parameter. To calculate each AC symbols, take the x value corresponding to the speed grade you need (-M, -V or -L) and replace this value in the formula. Values of the frequency must be limited to the corresponding speed grade:

Table 17. Max frequency for derating formula regarding the speed grade

	-M X1 mode	-M X2 mode	-V X1 mode	-V X2 mode	-L X1 mode	-L X2 mode
Freq (MHz)	40	20	40	30	30	20
T (ns)	25	50	25	33.3	33.3	50

Example:

 T_{LLIV} in X2 mode for a -V part at 20 MHz (T = $1/20^{E6}$ = 50 ns):

x= 25 (Table 20.)

T= 50ns

 $T_{LLIV} = 2T - x = 2 \times 50 - 25 = 75$ ns



7.5.4 External Data Memory Characteristics

Table 21. Symbol Description

Symbol	Parameter
T _{RLRH}	RD Pulse Width
T _{WLWH}	WR Pulse Width
T _{RLDV}	RD to Valid Data In
T _{RHDX}	Data Hold After RD
T _{RHDZ}	Data Float After RD
T _{LLDV}	ALE to Valid Data In
T _{AVDV}	Address to Valid Data In
T _{LLWL}	ALE to WR or RD
T _{AVWL}	Address to \overline{WR} or \overline{RD}
T _{QVWX}	Data Valid to WR Transition
T _{QVWH}	Data set-up to WR High
T _{WHQX}	Data Hold After WR
T _{RLAZ}	RD Low to Address Float
T _{WHLH}	$\overline{\text{RD}}$ or $\overline{\text{WR}}$ High to ALE high





7.5.6 External Data Memory Read Cycle



Figure 16. External Data Memory Read Cycle

7.5.7 Serial Port Timing - Shift Register Mode

Table 24. Symbol Description

Symbol	Parameter
T _{XLXL}	Serial port clock cycle time
T _{QVHX}	Output data set-up to clock rising edge
T _{XHQX}	Output data hold after clock rising edge
T _{XHDX}	Input data hold after clock rising edge
T _{XHDV}	Clock rising edge to input data valid

Table 25. AC Parameters for a Fix Clock

Speed	-1 40 N	M MHz	- X2 r 30 N 60 MH	V node ⁄IHz z equiv.	- standar 40 N	V •d mode ⁄IHz		L node ⁄IHz z equiv.	standar 30 N	L [.] d mode ⁄IHz	Units
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
T _{XLXL}	300		200		300		300		400		ns
T _{QVHX}	200		117		200		200		283		ns
T _{XHQX}	30		13		30		30		47		ns
T _{XHDX}	0		0		0		0		0		ns
T _{XHDV}		117		34		117		117		200	ns



Symbol	Туре	Standard Clock	X2 Clock	-М	-V	-L	Units
T _{XLXL}	Min	12 T	6 T				ns
T _{QVHX}	Min	10 T - x	5 T - x	50	50	50	ns
T _{XHQX}	Min	2 T - x	T - x	20	20	20	ns
T _{XHDX}	Min	X	Х	0	0	0	ns
T _{XHDV}	Max	10 T - x	5 T- x	133	133	133	ns

 Table 26. AC Parameters for a Variable Clock: derating formula

7.5.8 Shift Register Timing Waveforms



Figure 17. Shift Register Timing Waveforms